

SMD Comm X8R HT150C Flex, Ceramic, 2200 pF, 10%, 100 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603



Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.15mm
S	0.58mm MIN
B	0.45mm +/-0.15mm

Packaging Specifications	
Packaging:	Bulk, Bag
Packaging Quantity:	1

General Information	
Series:	SMD Comm X8R HT150C Flex
Style:	SMD Chip
Description:	SMD, MLCC, High Temperature, Ultra-Stable
Features:	Ultra-Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	7300 ug
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	2200 pF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	10%
Voltage DC:	100 VDC
Dielectric Withstanding Voltage:	250 VDC
Temperature Range:	-55/+150°C
Temperature Coefficient:	X8R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	2.5% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	100 GOhms

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